RoHS

COMPLIANT

HALOGEN



Vishay General Semiconductor

Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

eSMP® Series



SlimSMAW (DO-221AD)

Cathode O Anode

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS			
I _{F(AV)}	5 A		
V _{RRM}	120 V		
I _{FSM}	100 A		
V_F at $I_F = 5$ A ($T_A = 125$ °C)	0.64 V		
T _J max.	175 °C		
Package	SlimSMAW (DO-221AD)		
Circuit configuration	Single		

FEATURES

- Low-profile package
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Compatible to SOD-128 package case outline
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: SlimSMAW (DO-221AD)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	VSS8D5M12	UNIT		
Device marking code		5M12			
Maximum repetitive peak reverse voltage	V_{RRM}	120	V		
Maximum average forward rectified current (fig.1)	I _{F(AV)} (1)	5	Α		
	I _{F(AV)} (2)	2.2			
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	100	А		
Operating junction temperature range	T _J ⁽³⁾	<u> </u>			
Storage temperature range	T _{STG}				

Notes

- (1) Mounted on 30 mm x 30 mm aluminum PCB pad areas
- (2) Free air, mounted on recommended copper pad area
- (3) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CO	TEST CONDITIONS		TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 2.5 A	T _A = 25 °C	V _F ⁽¹⁾	0.62	-	V
	I _F = 5 A			0.81	0.89	
	$I_F = 2.5 A$	T _A = 125 °C		0.53	-	
	I _F = 5 A			0.64	0.74	
Reverse current	V _B = 90 V	T _A = 25 °C T _A = 125 °C	I _R ⁽²⁾	0.01	-	mA
	v _R = 90 v	T _A = 125 °C		0.9	-	
	V _R = 120 V	T _A = 25 °C T _A = 125 °C		-	0.35	
	v _R = 120 v	T _A = 125 °C		1.6	6	
Typical junction capacitance	4.0 V, 1 MH	4.0 V, 1 MHz		460	-	pF

Notes

 $^{(1)}$ Pulse test: 300 μ s pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise specified)				
PARAMETER SYMBOL TYP. MAX. UNIT				
Typical thermal resistance	R ₀ JA (1)(2)	120	150	°C/W
Typical trieffial resistance	R _{0JM} (3)	10	12	C/VV

Notes

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$
- (2) Thermal resistance junction-to-ambient to follow JEDEC® 51-2A, device mounted on FR4 PCB, 2 oz., standard footprint
- (3) Thermal resistance junction-to-mount to follow JEDEC 51-14 transient dual interface test method (TDIM)

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
VSS8D5M12-M3/H	0.033	Н	3500	7" diameter plastic tape and reel		
VSS8D5M12-M3/I	0.033	I	14 000	13" diameter plastic tape and reel		
VSS8D5M12HM3/H (1)	0.033	Н	3500	7" diameter plastic tape and reel		
VSS8D5M12HM3/I (1)	0.033	I	14 000	13" diameter plastic tape and reel		

Note

(1) AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

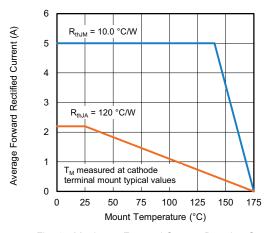


Fig. 1 - Maximum Forward Current Derating Curve

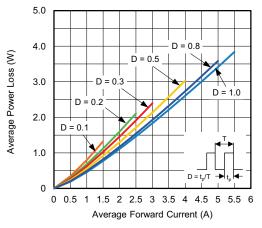


Fig. 2 - Forward Power Loss Characteristics

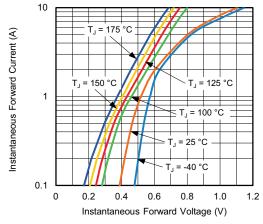


Fig. 3 - Typical Instantaneous Forward Characteristics

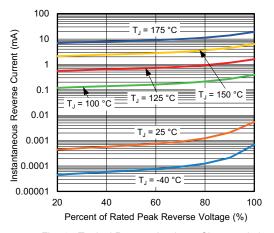


Fig. 4 - Typical Reverse Leakage Characteristics

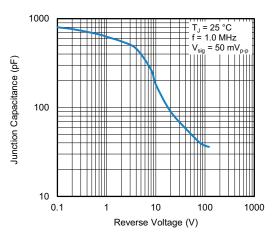


Fig. 5 - Typical Junction Capacitance

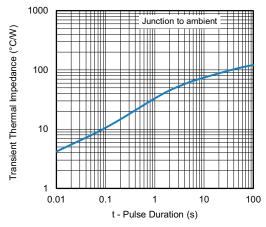


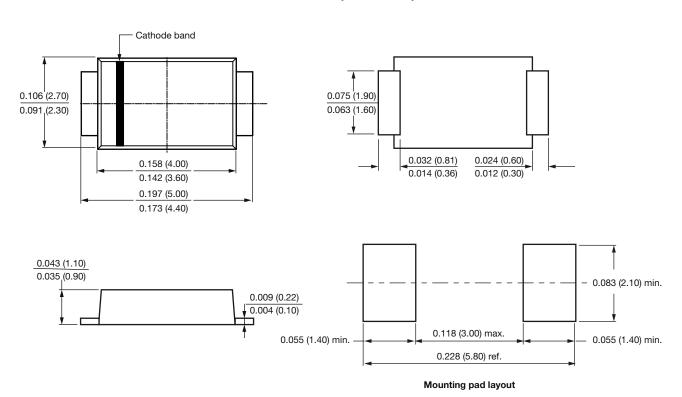
Fig. 6 - Typical Transient Thermal Impedance



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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SlimSMAW (DO-221AD)





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